

COMPACT HIGH POWER RELAY

1 POLE - 40A (For automotive applications)

FBR53-HW Series

■ FEATURES

- Small 40A relay
- High temperature grade (-40°C to 125°C)
- Contact arrangement Form U (form A)
- Surface mount compatible (reflow capability)
- Inrush current 80A
- Coil wire temperature class: H

■ Part Numbers

[Example] FBR53 N D12 - Y - HW - RW
 (a) (b) (c) (d) (e) (f)

| | | |
|-----|--------------------|--|
| (a) | Relay type | FBR53 : FBR53 series |
| (b) | Enclosure | N : Plastic sealed type |
| (c) | Coil rated voltage | D12 : 9...12VDC Coil rating table at page 3 |
| (d) | Contact material | Y : Silver-tin oxide |
| (e) | Contact rating | HW : 40A |
| (f) | Soldering | Nil : Standard (Flow soldering) RW : Reflow capable (THR) |

Actual markings does not carry the type name: "FBR"
 E.g.: Ordering code: FBR53ND12-Y-HW Actual marking: 53ND12-Y-HW



FBR53-HW Series

■ Specifications

| Item | FBR53-HW | | Remarks / conditions | |
|---------------------|---------------------------------|---------------------------------|--|--|
| Contact data | Configuration | | 1 form U | |
| | Material | | Silver-tin oxide | |
| | Voltage drop | | Max. 100 mV at 1A, 12VDC. Average 1.2mΩ at 7A, 12VDC | |
| | Contact rating | | 40A, 14VDC | Resistive load |
| | Max. carrying current | | 40A | |
| | Max. inrush current | | 80A | Reference |
| | Min. switching load | | 1A 6VDC | Reference * |
| Coil | Rated power consumption | | 860mW | At 20°C |
| | Operate power consumption | | 310mW | At 20°C |
| | Operating temperature range | | -40°C ~ +125°C | No frost |
| Timing data | Operate | | Max. 10ms | At nominal voltage |
| | Release | | Max. 10ms | At nominal voltage |
| Life | Mechanical | | Min. 1 x 10 ⁶ operations | without contact load |
| | Electrical | | Min. 100 x 10 ³ operations | 14VDC, 40A resistive load |
| Insulation | Insulation resistance | | Min. 100MΩ | Initial |
| | Dielectric withstanding voltage | Open contacts | 500VAC (50/60Hz), 1 minute | |
| | | Coil contact | 500VAC (50/60Hz), 1 minute | |
| Other | Vibration resistance | Misoperation | 10 to 200Hz, acceleration 44m/s ² (4.4G) constant acceleration | |
| | | Endurance | 10 to 200Hz, acceleration 44m/s ² (4.4G) constant acceleration | |
| | Shock resistance | Misoperation | 100m/s ² (11±1ms) | Direction X, Y, Z, contact ON/OFF total 36 times |
| | | Endurance | 1,000m/s ² (6±1ms) | Direction X, Y, Z, contact OFF total 18 times |
| Dimensions / weight | | 12.3 x15.7x14.0 mm / approx. 6g | | |

*: Minimum switching loads mentioned above are reference values. Please perform the confirmation test with actual load before production since reference values may vary according to switching frequencies, environmental conditions and expected reliability levels. Care shall be taken on the heat generated on PC board when maximum carrying current exceeds 10A. Please perform the confirmation test with actual conditions.

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■ Coil Data

| Coil code | Rated Coil Voltage (VDC) | Coil Resistance +/-10% (Ω) | Must Operate Voltage* (VDC) | Must Release Voltage* (VDC) |
|-----------|--------------------------|-------------------------------------|-----------------------------|-----------------------------|
| D09 | 9 | 94 | 5.4 7.7 (at 125°C) | 0.7 1.0 (at 125°C) |
| D10 | 10 | 117 | 6.3 9 (at 125°C) | 0.8 1.2 (at 125°C) |
| D12 | 12 | 167 | 7.3 10.4 (at 125°C) | 1.0 1.5 (at 125°C) |

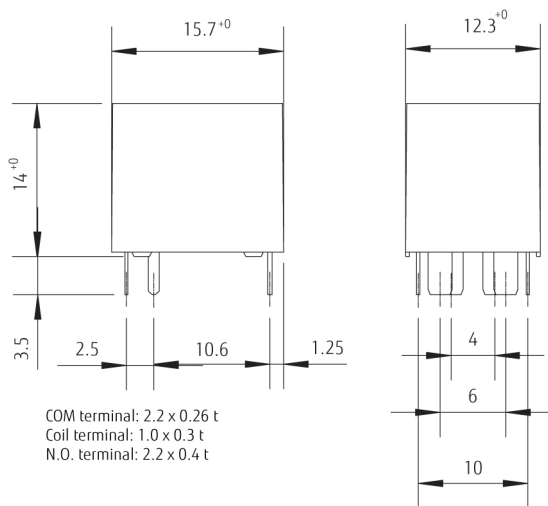
Note: All values in the table are valid at 20°C and zero contact current, unless otherwise specified.

*: Specified operated values are valid for pulse wave voltage.

Please use at rated coil voltage. Please refer to characteristic data and set up adequate voltage in case of use at over voltage.

■ Dimensions

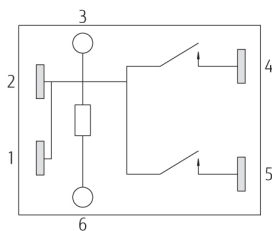
• Dimensions



Dimensions of the terminals do not include thickness of pre-solder.

• Schematics

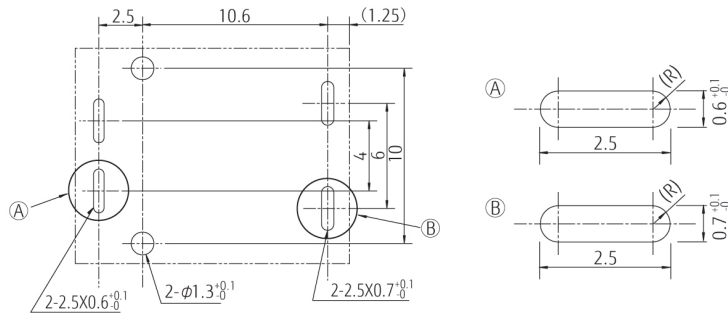
(BOTTOM VIEW)



Pattern shall be designed to short-circuit #4 and #5 on the PC board.

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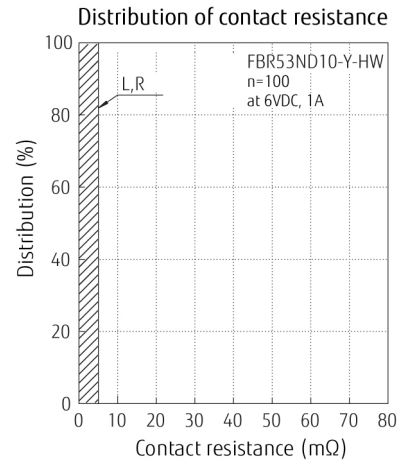
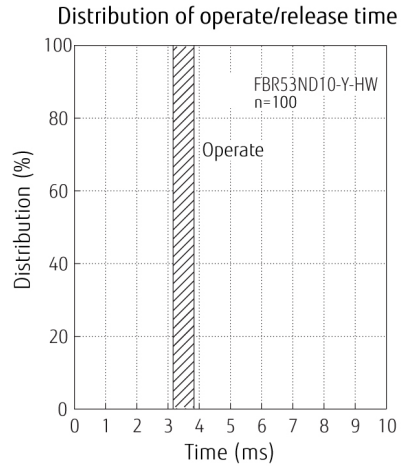
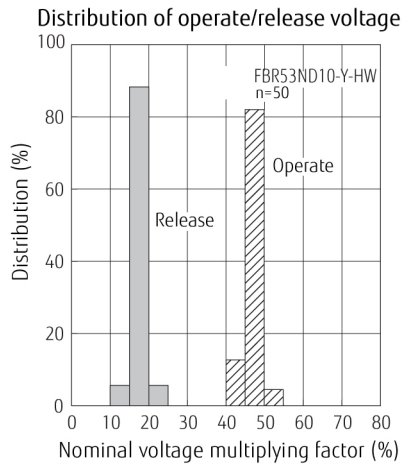
- PC Board Mounting Hole Layout (BOTTOM VIEW)



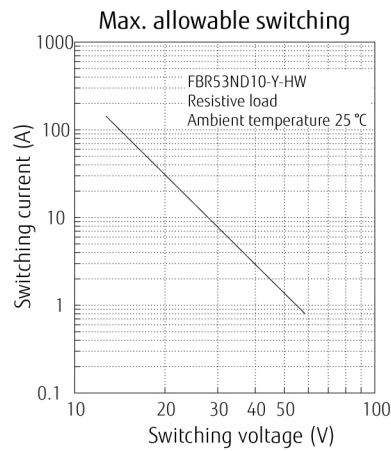
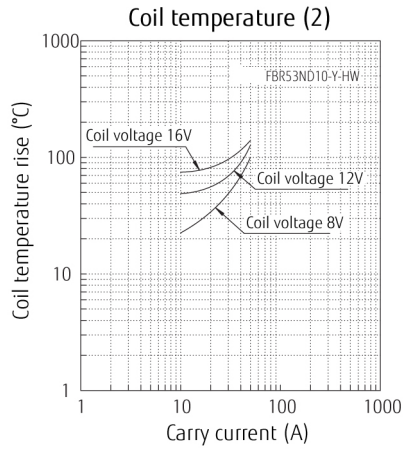
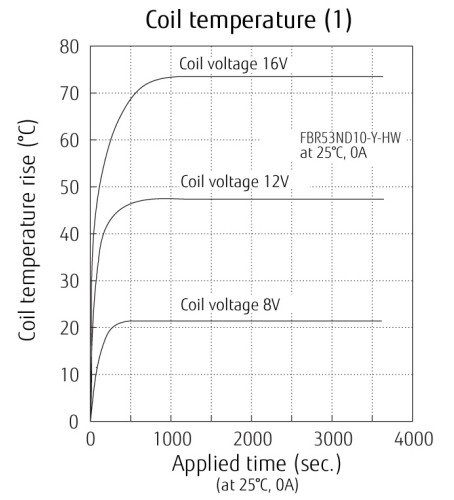
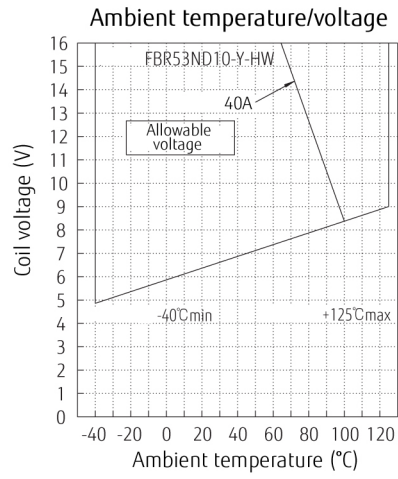
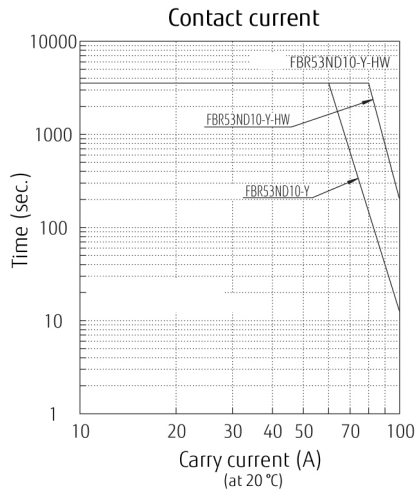
Tolerance of PC board mounting hole layout : ± 0.1 unless otherwise specified.

(): Reference value
Unit: mm

■ Characteristic Data (Reference)



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GENERAL INFORMATION

1. ROHS Compliance

- All relays produced by Fujitsu Components are compliant with RoHS directive 2011/65/EU including amendments.
- Use of Cadmium in electrical contacts is exempted as per Annex III of the RoHS directive 2001/65/EU. Please consider expiry date of exemption. Relays with Cadmium containing contacts are not to be used for new designs.
- All relays are lead-free. Please refer to Lead-Free Status Info for older date codes at: <http://www.fujitsu.com/downloads/MICRO/fcai/relays/lead-free-letter.pdf>

2. Recommended lead free solder condition

- Lead free solder plating on relay terminals is Sn-3.0Ag-0.5Cu, unless otherwise specified. This material has been verified to be compatible with PbSn assembly process.
- Recommended solder for assembly: Sn-3.0Ag-0.5Cu.

Flow Solder Condition:

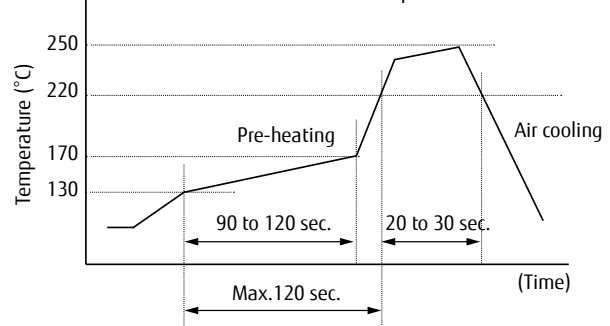
Pre-heating: maximum 120°C within 90 sec.
Soldering: dip within 5 sec. at 255°C ± 5°C solder bath
Relay must be cooled by air immediately after soldering

Solder by Soldering Iron:

Soldering Iron 30-60W
Temperature: maximum 350-360°C
Duration: maximum 3 sec.

Recommended reflow soldering profile IRS (infrared reflow soldering)

Peak temperature: Max.250°C



Important Notes for Reflow Soldering

- Temperature shall be measured at PC board upper surface.
- Temperature at PC board upper surface may be changed depending on size of PC board, components mounted on the PC board and/or heating method. Please perform the confirmation test with your actual PC boards.
- This reflow solder condition is applicable only for reflow-capable relays. Do not reflow reflow-incapable relays.
- Recommended solder for assembly: Sn-3.0 Ag-0.5 Cu.

We highly recommend that you confirm your actual solder conditions

3. Moisture Sensitivity

- Moisture Sensitivity Level standard is not applicable to electromechanical relays, unless otherwise indicated. -RW THR relay will be shipped in moisture barrier bag.

4. Tin Whiskers

- Dipped SnAgCu solder is known as presenting a low risk to tin whisker development. No considerable length whisker was found by our in house test.

FBR53-HW Series

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| | | |
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